NCE N-Channel Enhancement Mode Power MOSFET

General Description

The NCE7578 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

Features

- V_{DS}=75V；I_D=78A@ V_{GS}=10V；
  $R_{DS(ON)}$<8.5mΩ @ V_{GS}=10V
- Special process technology for high ESD capability
- Special designed for Convertors and power controls
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

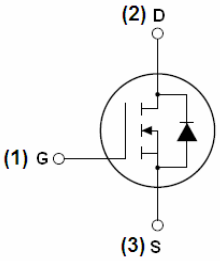
- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Product Summary

BV_{DSS}	typ.	84	V
$R_{DS(ON)}$	typ.	7.0	mΩ
	max.	8.5	mΩ
I_D		78	A

100% UIS TESTED!

TO-220-3L top view



Schematic diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE7578	NCE7578	TO-220-3L	-	-	-

Table 1. Absolute Maximum Ratings (T_C=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V_{GS}=0V)	V_{DS}	75	V
Gate-Source Voltage (V_{DS}=0V)	V_{GS}	±20	V
Drain Current (DC) at Tc=25℃	$I_{D\ (DC)}$	78	A
Drain Current (DC) at Tc=100℃	$I_{D\ (DC)}$	55	A
Drain Current-Continuous@ Current-Pulsed (Note 1)	$I_{DM\ (pluse)}$	300	A
Peak diode recovery voltage	dv/dt	30	V/ns
Maximum Power Dissipation(Tc=25℃)	P_D	160	W
Derating factor		1.07	W/℃
Single pulse avalanche energy (Note 2)	E_{AS}	550	mJ
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 175	℃

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition：Tj=25℃,VDD=37.5V,VG=10V,L=0.5mH

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance，Junction-to-Case（Maximum）	R_{thJC}	0.94	℃/W
Thermal Resistance，Junction-to-Ambient （Maximum）	R_{thJA}	63	℃/W

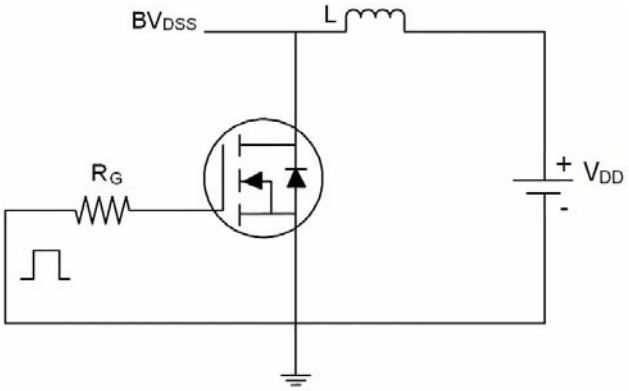
Table 3. Electrical Characteristics (T_C=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	75	84	-	V
Zero Gate Voltage Drain Current(Tc=25℃)	I_{DSS}	V_{DS}=75V,V_{GS}=0V	-	-	1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I_{DSS}	V_{DS}=75V,V_{GS}=0V	-	-	10	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA	2	2.85	4	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=40A	-	7	8.5	mΩ
Dynamic Characteristics						
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=30A	-	60	-	S
Input Capacitance	C_{lss}	V_{DS}=25V,V_{GS}=0V, F=1.0MHz	-	3400	-	PF
Output Capacitance	C_{oss}		-	290	-	PF
Reverse Transfer Capacitance	C_{rss}		-	221	-	PF
Total Gate Charge	Q_g	V_{DS}=30V,I_D=30A, V_{GS}=10V	-	94	-	nC
Gate-Source Charge	Q_{gs}		-	16	-	nC
Gate-Drain Charge	Q_{gd}		-	24	-	nC
Switching times						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=30V,I_D=2A,R_L=15Ω V_{GS}=10V,R_G=2.5Ω	-	15	-	nS
Turn-on Rise Time	t_r		-	11	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	52	-	nS
Turn-Off Fall Time	t_f		-	13	-	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I_{SD}		-	-	78	A
Pulsed Source-drain current(Body Diode)	I_{SDM}		-	-	312	A
Forward on voltage(Note 1)	V_{SD}	Tj=25℃,I_{SD}=40A,V_{GS}=0V	-	-	1.2	V
Reverse Recovery Time(Note 1)	t_{rr}	Tj=25℃,I_F=75A,di/dt=100A/μs	-	-	33	nS
Reverse Recovery Charge(Note 1)	Q_{rr}		-	-	54	nC
Forward Turn-on Time	t_{on}	Intrinsic turn-on time is negligible(turn-on is dominated by L_S+L_D)				

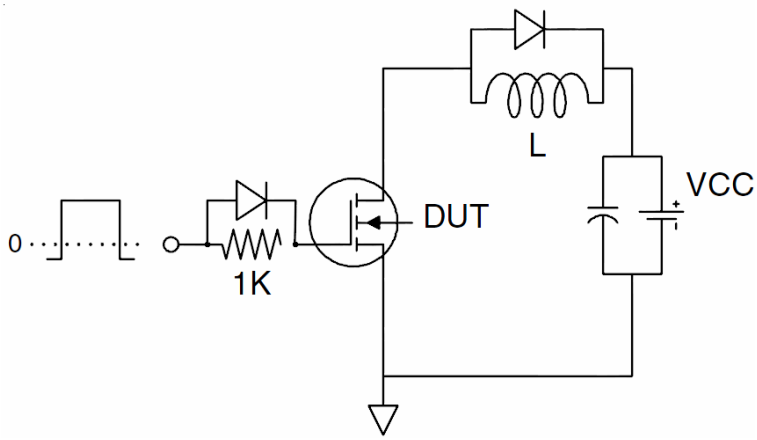
Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%, R_G=25Ω, Starting Tj=25℃

Test Circuit

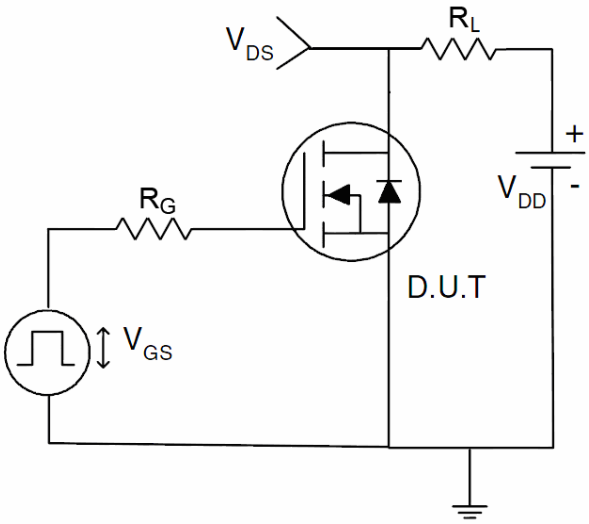
1) E_{AS} test circuit



2) Gate charge test circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (curves)

Figure1. Safe operating area

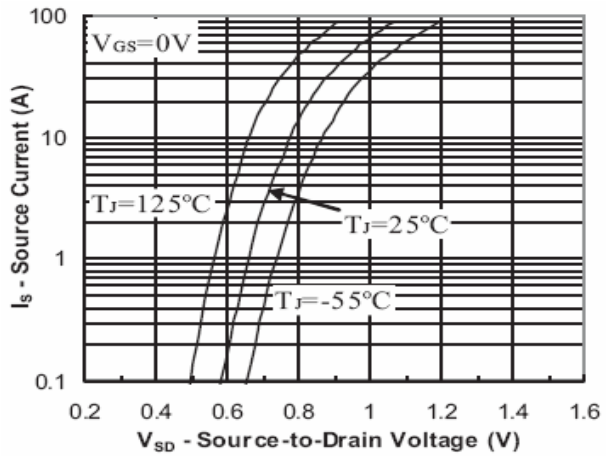


Figure2. Source-Drain Diode Forward Voltage

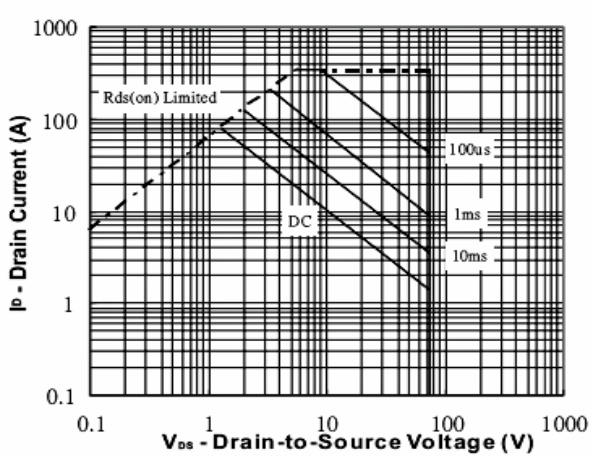


Figure3. Output characteristics

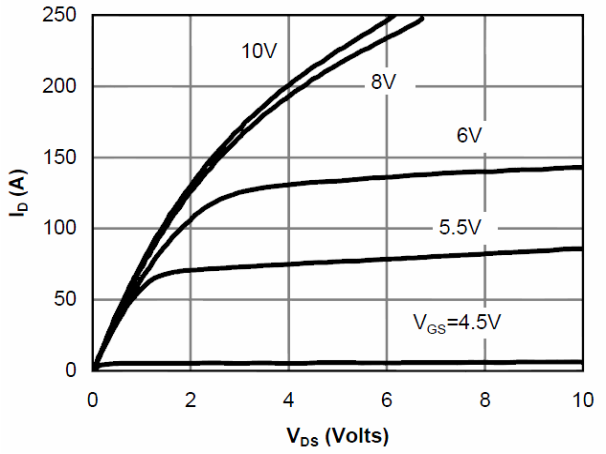


Figure4. Transfer characteristics

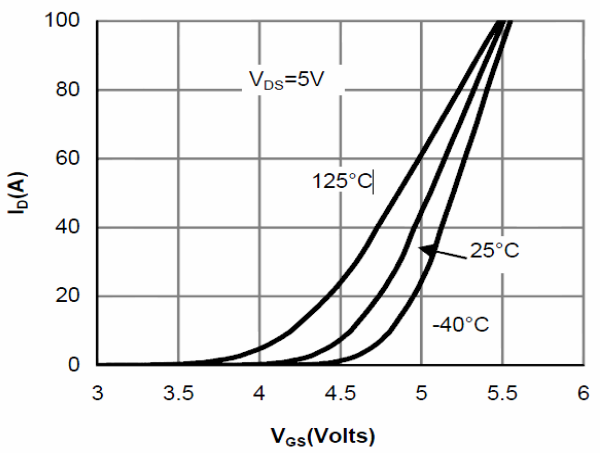


Figure5. Static drain-source on resistance

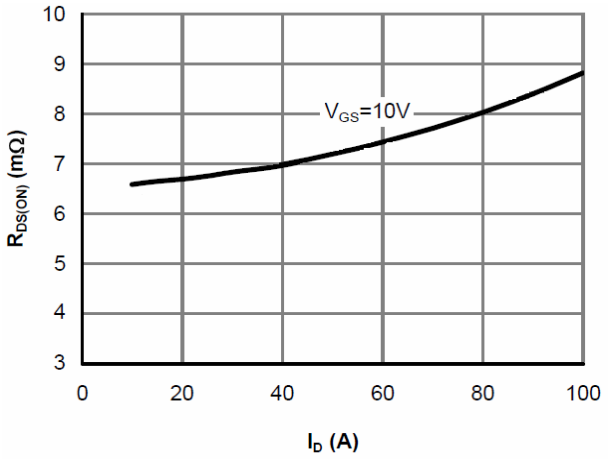


Figure6. $R_{DS(ON)}$ vs Junction Temperature

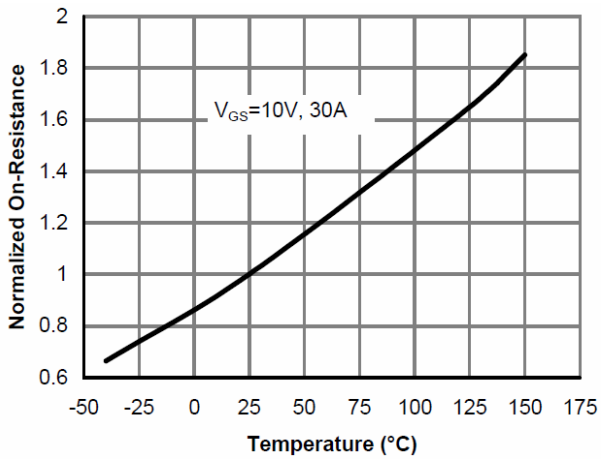


Figure7. BV_{DSS} vs Junction Temperature

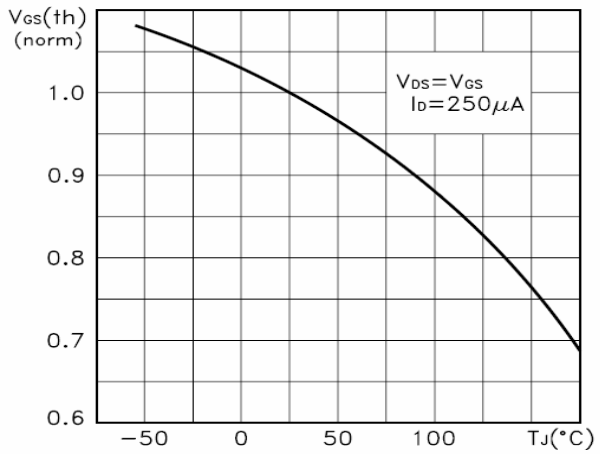


Figure8. $V_{GS(th)}$ vs Junction Temperature

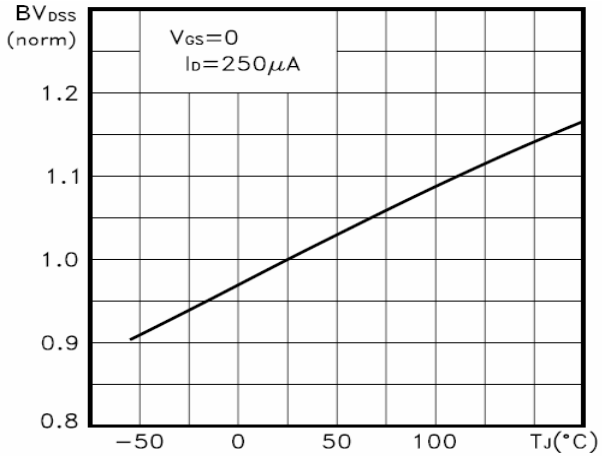


Figure9. Capacitance

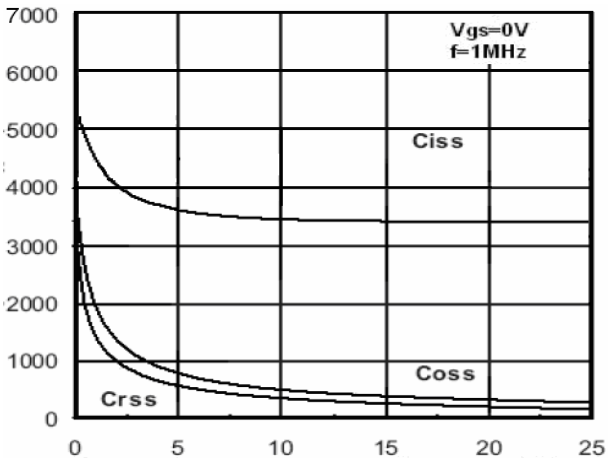


Figure10. Gate charge waveforms

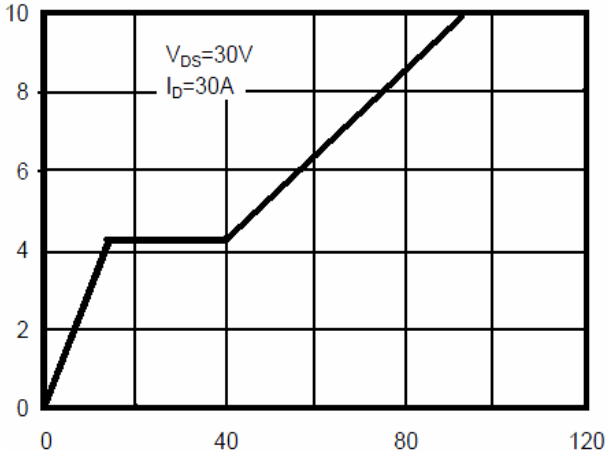
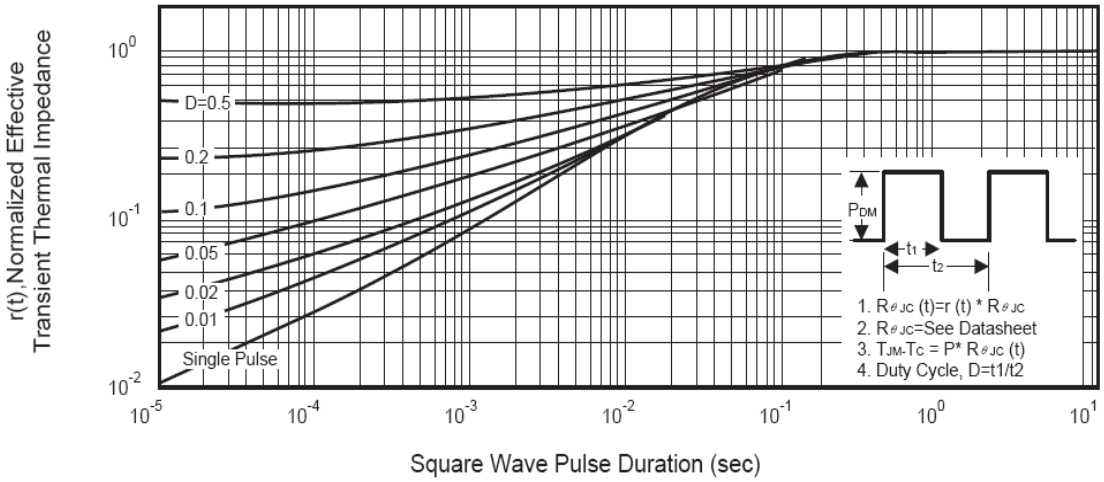
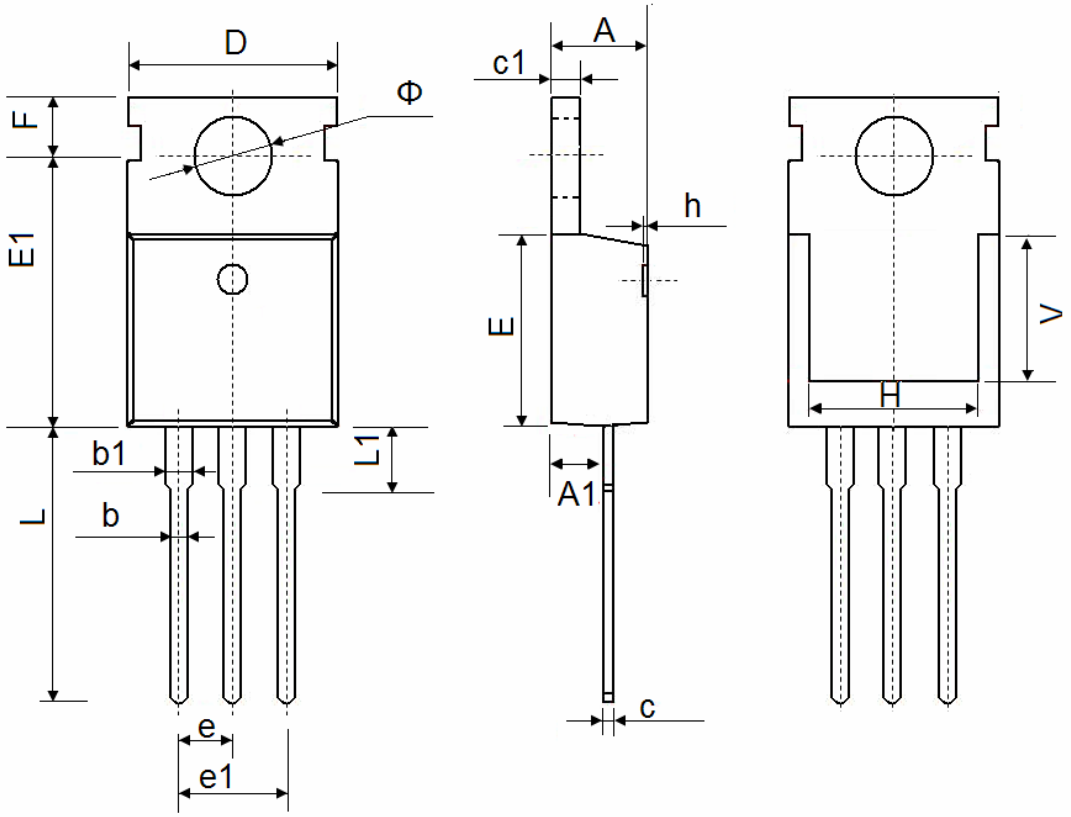


Figure11. Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
Φ	3.400	3.800	0.134	0.150

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